

EGPC-B1S1

M.2 2242 to single isolated

CAN bus 2.0B

Customer:

Customer

Part Number:

Innodisk

Part Number:

Innodisk

Model Name:

Date:

Innodisk	Customer
Approver	Approver

Total Solution For
Embedded Peripherals

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REVISION HISTORY

Revision	Description	Date
1.0	First Released	Mar, 2021
1.1	Modify Termination Resistor Setting	Oct, 2022

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1. Product Introduction

1.1. Overview

Innodisk EGPC-B1S1 is designed with standard M.2 2242 form factor with; EGPC-B1S1 supports PCIe to single CAN bus 2.0B port, optimized for higher performance and lower power, which brings you a flexible expansion solution for embedded systems.

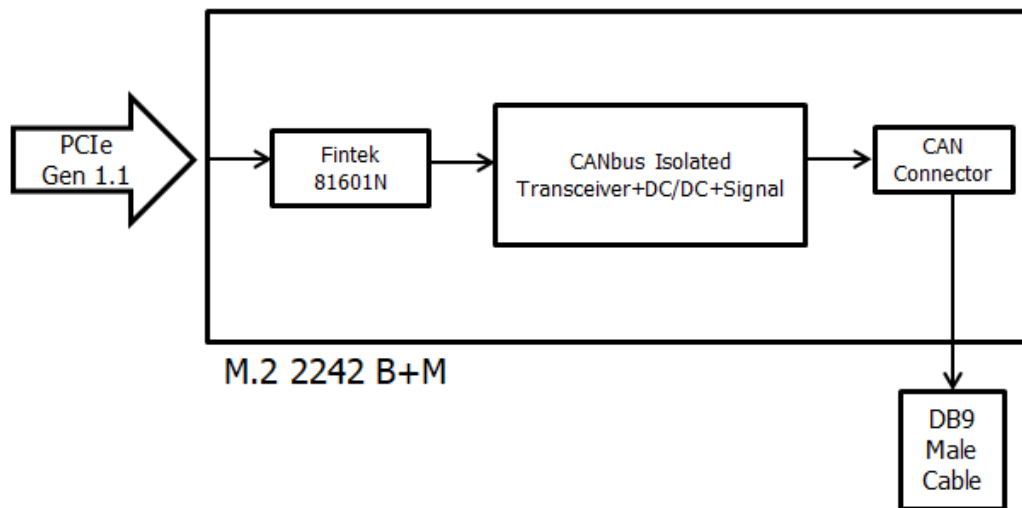


Figure 1: M.2 Board Block Diagram

1.2. Features

- Compliant with PCI Express 1.1
- Meet the Requirements of the ISO 11898-1
- CAN bus 2.0B backward compatible with 2.0A
- Support baud rate 10/20/50/100/250/500/800/1000K
- Support CAN message acceptance filter
- Support Linux SocketCAN
- Compliant with IEC 60950-1:2005 + A1: 2009 + A2:2013 2.5kV HiPOT protection
- Compliant with EN61000-4-2 (ESD) Air- 15kV, Contact-8kV
- Termination resistor enabled/disabled by switch
- 30μ" golden finger, 3-year warranty
- Industrial Temperature (-40°C to +85°C) support

- Industrial design, manufactured in Innodisk Taiwan



Figure 2: Picture

2. Product Specifications

2.1. Device Parameters

Table 1: Device Parameters

Form Factor	M.2 2242 B-M
Input I/F	PCI Express 1.1
Output I/F	CAN bus 2.0B
Output Connector	DB-9 x 1
Dimension (WxLxH)	22 x 42 x 4.8 mm

2.2. Performance

In performance test, we use our own stress test tool to verify the TX/RX performance.

Table 2: Two Cards TX/RX

ID Type	Bytes	TX (frames/sec)	RX (frames/sec)
SID	0	12149	12122
	1	10622	10594
	2	9571	9557
	3	8512	8499
	4	7460	7443
	5	6580	6568

	6	6300	6290
	7	5742	5728
	8	5440	5430
EID	0	9056	9033
	1	7698	7684
	2	6946	6929
	3	6596	6577
	4	6206	6190
	5	5555	5541
	6	5392	5377
	7	5067	5057
	8	4548	4539

2.3. Electrical Specifications

2.3.1. Power Requirement

Table 3: Power Requirement

Item	Connector	Rating
Input voltage	M.2 Golden Finger	+3.3 DC +- 5%

2.3.2. Power Consumption

Table 4: Power Consumption

Voltage(V)	RMS(mA)	Max (mA)
3.3	318	742

2.4. Environmental Specifications

2.4.1. Temperature Ranges

Table 5: Temperature Ranges

Temperature	Range
Operating	Industrial Grade: -40°C to +85°
Storage	-55°C to +95°

2.4.2. Humidity

Relative Humidity: 10-95%, non-condensing

2.4.3. Shock and Vibration

Table 6: Shock and Vibration

Reliability	Test Conditions	Reference Standards
Vibration	7 Hz to 2K Hz, 20G, 3 axes	IEC 68-2-6
Mechanical Shock	Duration: 0.5ms, 1500 G, 3 axes	IEC 68-2-27

2.4.4. Mean Time between Failure (MTBF)

Reliability prediction methodology provides the basis for reliability evaluation and analysis. The purpose of the prediction is to predict the life time of the product in units of failure rate and MTBF.

Table 7: Mean Time between Failure (MTBF)

Product	Condition	MTBF (Hours)
EGPC-B1S1	The analysis is at 25°C ambient temperature by Telcordia SR-332, Issues 4, Method I, Case 3 under Ground Benign, Controlled environment, 50% operation stress	37,788,722

2.5. CE and FCC Compatibility

EGPC-B1S1 conforms to CE and FCC requirements.

2.6. RoHS Compliance

EGPC-B1S1 is fully compliant with RoHS directive.

2.7. Hardware

2.7.1. Layout

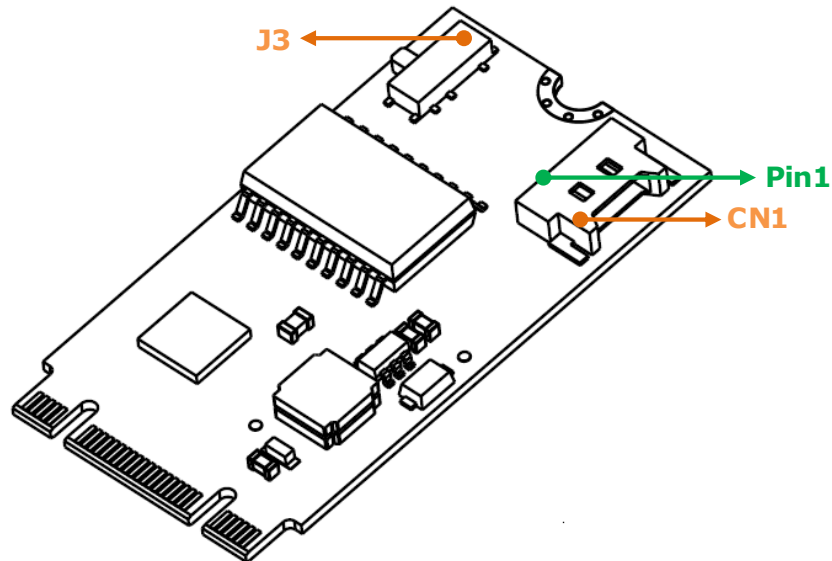


Table 8: PCB Layout Legend

Label	Connector Type	Function
CN1	SMD 1*3P 90° P:1.25mm H:1.85mm	CAN bus Port
J3	SLIDE SWITCH	Enable Termination Resistor

2.7.2. Pin Define

Table 9: M.2 B-M Key Pin Define

Signal Name	Pin #	Pin #	Signal Name
		75	CONFIG_2
3.3V	74	73	GND
3.3V	72	71	GND
3.3V	70	69	CONFIG_1
NC	68	67	NC
Module Key M			

NC	58		
NC	56	57	GND
NC	54	55	CLK+
GND	52	53	CLK-
RST	50	51	GND
NC	48	49	RX+
NC	46	47	RX-
NC	44	45	GND
NC	42	43	TX+
NC	40	41	TX-
NC	38	39	GND
NC	36	37	NC
NC	34	35	NC
NC	32	33	GND
NC	30	31	NC
NC	28	29	NC
NC	26	27	GND
NC	24	25	NC
NC	22	23	NC
NC	20	21	CONFIG_0
Module Key B			
NC	10	11	NC
NC	8	9	NC
NC	6	7	NC
3.3V	4	5	NC
3.3V	2	3	GND
		1	CONFIG_3

2.7.3. I/O Connector Mechanical Drawing & Pin Defines

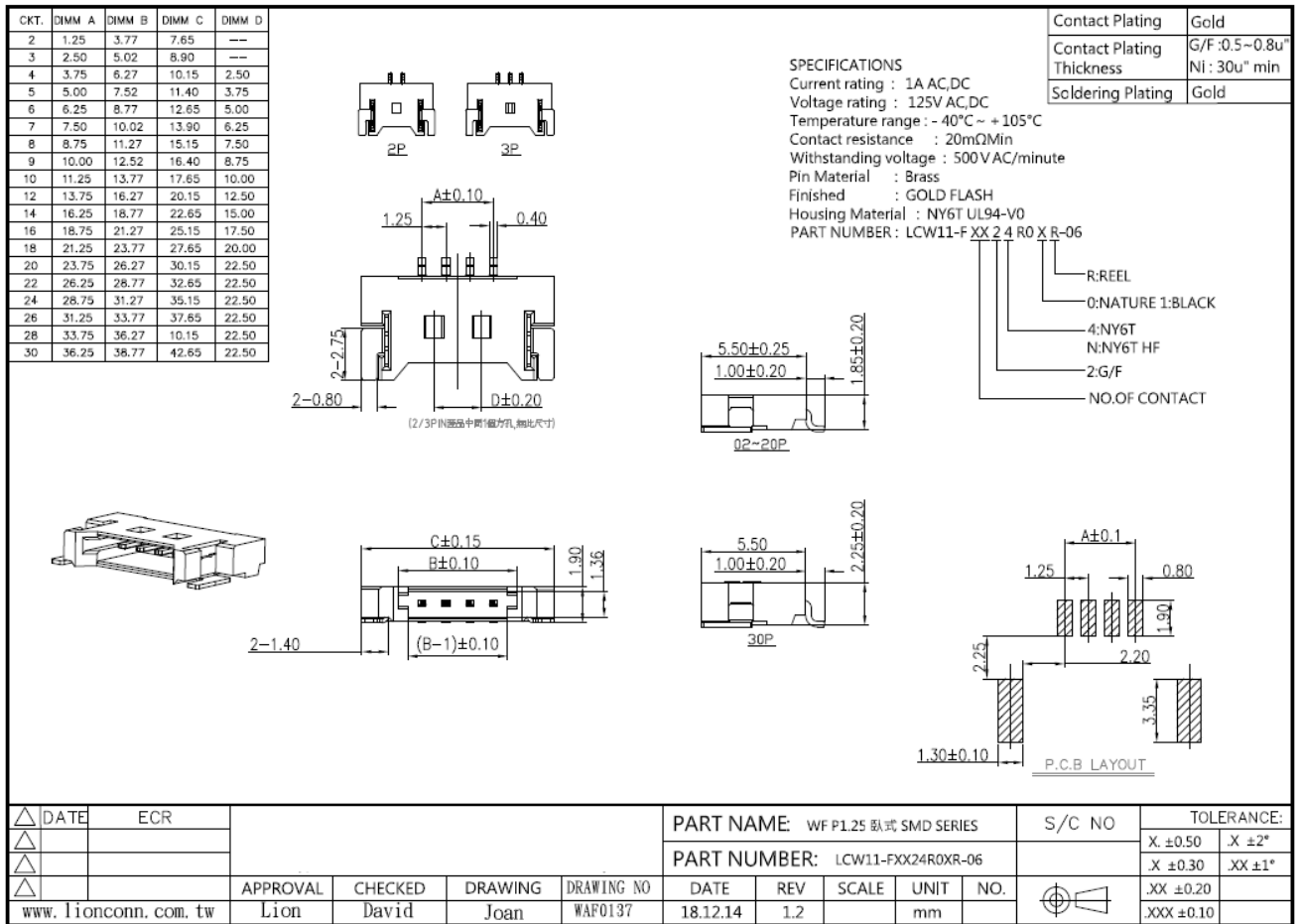


Figure 3: Wire to Board SMD 1*3P Connector Drawing (CN1-CN4)

Table 10: Wire to Board SMD 1*3P Connector Pin Define (CN1-CN4)

Pin #	1	2	3
Signal Name	CAN-L	CAN-H	GND

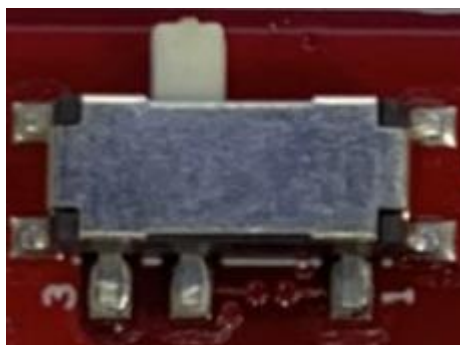


Figure 4: Slide Switch Enable Termination Resistor (J3)



Figure 5: Slide Switch Disable Termination Resistor (J3)

Table 11: Slide Switch Pin Define (J3)

Pin #	1	3
Termination Resistor	ON	OFF

2.7.4. EGPC-B1S1 Mechanical Drawing

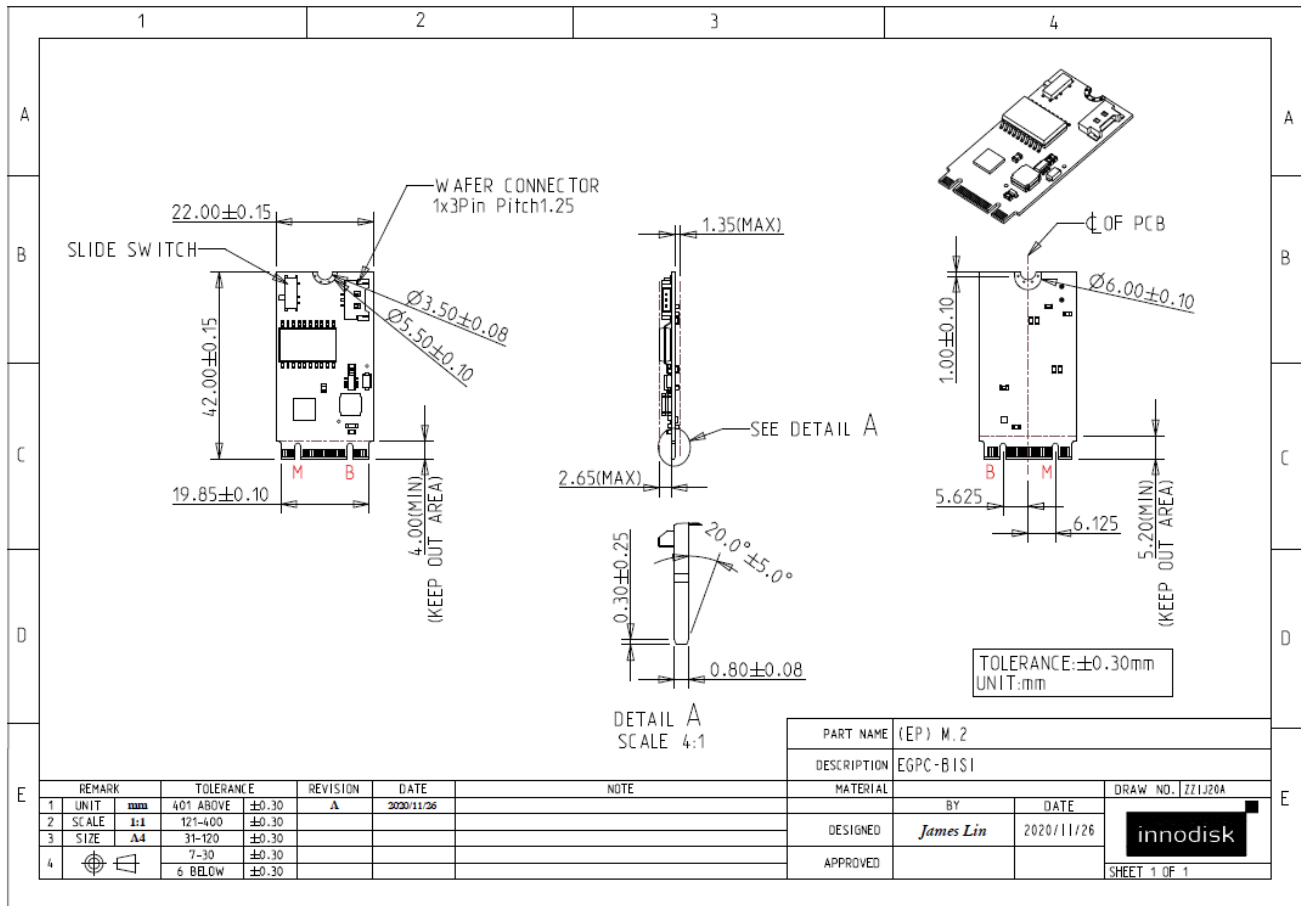


Figure 6: EGPC-B1S1 Drawing

2.7.5. Cable Mechanical Drawing & Pin Defines

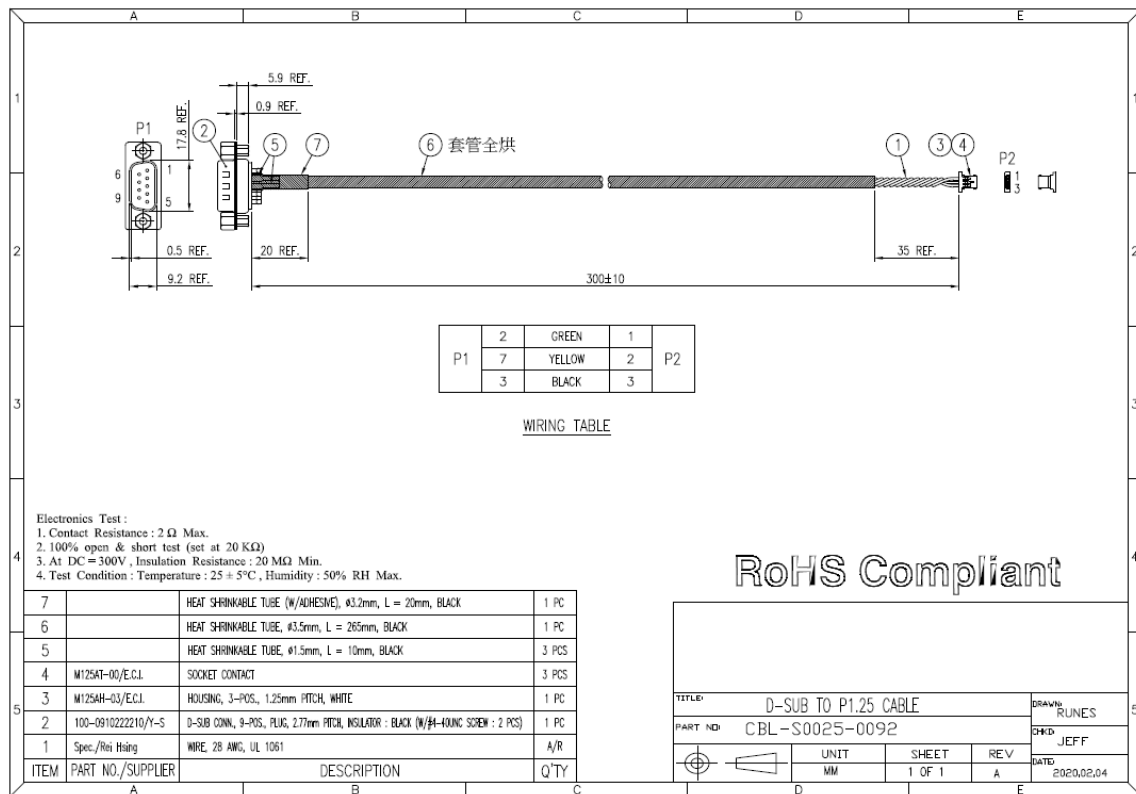


Figure 7: DB9 Cable Drawing

Table 12: DB9 Cable Pin Define

Pin #	1	2	3	4	5	6	7	8	9
Signal Name	NC	CAN-L	GND	NC	NC	NC	CAN-H	NC	NC

2.7.6. Packing List

- EGPC-B1S1 M.2 2242 board x1
- DB9 Cable x1

2.8. Software Support

Windows	7(32/64bit), 8/8.1(32/64bit), 10(32/64bit)
Linux (SocketCAN driver)	Kernel 2.6.38 and above, 32/64bit

3. Installation Guide

Please download driver, software API and user manual from Myinnodisk web site.

<https://myinnodisk.innodisk.com/myinnodisk/Login.aspx>

4. Appedix

innodisk

宜鼎國際股份有限公司 Innodisk Corporation

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RoHS 自我宣告書 (RoHS Declaration of Conformity)

Manufacturer Products: All Innodisk EM FLASH, DRAM and EP products

- 一、 宜鼎國際股份有限公司（以下稱本公司）特此保證售予貴公司之所有產品，皆符合歐盟 2011/65/EU 及 (EU) 2015/863 關於 RoHS 之規範要求。
Innodisk Corporation declares that all products sold to the company, are complied with European Union RoHS Directive (2011/65/EU) and (EU) 2015/863 requirement.
- 二、 本公司同意因本保證書或與本保證書相關事宜有所爭議時，雙方宜友好協商，達成協議。
Innodisk Corporation agrees that both parties shall settle any dispute arising from or in connection with this Declaration of Conformity by friendly negotiations.
- 三、 本公司聲明我們的產品符合 RoHS 指令的附件中 (7a)、(7c-I) 允許豁免。
We declare, our products permitted by the following exemptions specified in the Annex of the RoHS directive.
- ※ (7a) Lead in high melting temperature type solders (i.e. lead-based alloys containing 85% by weight or more lead).
- ※ (7C-I) Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectric devices, or in a glass or ceramic matrix compound.

Name of hazardous substance	Limited of RoHS ppm (mg/kg)
鉛 (Pb)	< 1000 ppm
汞 (Hg)	< 1000 ppm
鎘 (Cd)	< 100 ppm
六價鉻 (Cr 6+)	< 1000 ppm
多溴聯苯 (PBBs)	< 1000 ppm
多溴二苯醚 (PBDEs)	< 1000 ppm
鄰苯二甲酸二(2-乙基己基)酯 (DEHP)	< 1000 ppm
鄰苯二甲酸丁酯苯甲酯 (BBP)	< 1000 ppm
鄰苯二甲酸二丁酯 (DBP)	< 1000 ppm
鄰苯二甲酸二異丁酯 (DIBP)	< 1000 ppm

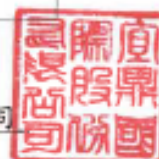
立 保 證 書 人 (Guarantor)

Company name 公司名稱: Innodisk Corporation 宜鼎國際股份有限公司

Company Representative 公司代表人: Randy Chien 簡川勝

Company Representative Title 公司代表人職稱: Chairman 董事長

Date 日期: 2020 / 03 / 03



宜鼎國際股份有限公司
Innodisk Corporation
REACH Declaration

Tel:(02)7703-3000 Fax:(02) 7703-3555 Internet: <https://www.innodisk.com/>

Innodisk Corporation pursues its social responsibility for global environmental preservation by committing to be compliant with REACH regulation (REGULATION (EC) No 1907/2006). We hereby confirm that the product(s),

Scope: Flash Memory, DRAM module and Embedded peripherals products.

- The standard products of not listed in the Appendix2 meet the requirements of REACH SVHC regulations (SVHCs < 0.1% in Article), as described in the candidate list table currently including 211 substances and shown on the ECHA website. (<http://echa.europa.eu/de/candidate-list-table>).
- Contain(s) one or more hazardous substances or constituents exceeding 0.1 % by weight in article if not otherwise specified in candidate list table.
Where the threshold value is exceeded, the substances in question are to be declared in accompanying. (SVHCs > 0.1% in Article).
- Comply with REACH Annex XVII.

Guarantor

Company name 公司名稱: Innodisk Corporation 宜鼎國際股份有限公司

Company Representative 公司代表人: Yichuan Chen 陳怡全

Company Representative Title 公司代表人職稱: QA Manager 品保經理

Date 日期: 2021 / 03 / 03

CERTIFICATE OF CONFORMITY



Product : M.2 CAN BUS Module
Brand : Innodisk
Test Model : EGPC-B1S1
Series Model : E%PC-B1S1
 %: Form factor: (2: 2.5"SSD, 3:DDR3 DIMM, D:Dongle,
 G:NGFF_M.2,H:mPCIe Half, L:PCIe Low profile, M:mPCIe, S:PCIe
 Standard, X:Multi, Z:Others)
Applicant : Innodisk Corporation
Report No. : CEBDBO-WTW-P21030857

We, **Bureau Veritas Consumer Products Services (H.K.) Ltd., Taoyuan Branch**, declare that the equipment above has been tested in our facility and found compliance with the requirement limits of applicable standards, in accordance with the Directive 2014/30/EU. The test record, data evaluation and Equipment Under Test (EUT) configurations represented herein are true and accurate under the standards herein specified.

EN 55032:2015 +A11:2020, Class B

EN 61000-3-2:2014 (Not applicable)

EN 61000-3-3:2013 (Not applicable)

EN 55035:2017 +A11:2020

EN 61000-4-2:2009 / IEC 61000-4-2:2008 ED. 2.0

EN 61000-4-3:2006 +A1:2008 +A2:2010 / IEC 61000-4-3:2010 ED. 3.2

EN 61000-4-4:2012 / IEC 61000-4-4:2012 ED. 3.0 (Not applicable)

EN 61000-4-5:2014 +A1:2017 / IEC 61000-4-5:2014 +A1:2017 ED. 3.0 (Not applicable)

EN 61000-4-6:2014 +AC:2015 / IEC 61000-4-6:2013 ED. 4.0 (Not applicable)

EN 61000-4-8:2010 / IEC 61000-4-8:2009 ED. 2.0

EN 61000-4-11:2004 +A1:2017 / IEC 61000-4-11:2004 +A1:2017 ED. 2.0 (Not applicable)

Broadband impulse noise disturbances (Not applicable)

NOTE: The above EN/IEC basic standards are applied with latest version if customer has no special requirement.

Jim Hsiang
 Jim Hsiang / Associate Technical Manager

Apr. 23, 2021



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TEST REPORT

CERTIFICATE OF CONFORMITY

Standards: 47 CFR FCC Part 15, Subpart B, Class B

ANSI C63.4:2014

Report No.: FDBDBO-WTW-P21030857

Model No.: EGPC-B1S1

Series Model: E%PC-B1S1

Form factor: (2: 2.5"SSD, 3:DDR3 DIMM, D:Dongle, G:NGFF_M.2, H:mPCIe Half, L:PCIe Low profile, M:mPCIe, S:PCIe Standard, X:Multi, Z:Others)

Received Date: Mar. 23, 2021

Test Date: Apr. 1 to 6, 2021

Issued Date: Apr. 23, 2021

Applicant: Innodisk Corporation

Address: 5F., No. 237, Sec. 1, Datong Rd., Xizhi Dist., New Taipei City 22161, Taiwan

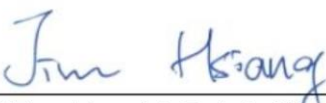
Issued By: Bureau Veritas Consumer Products Services (H.K.) Ltd., Taoyuan Branch Lin Kou Laboratories

Lab Address: No. 47-2, 14th Ling, Chia Pau Vil., Lin Kou Dist., New Taipei City, Taiwan

FCC Registration /

Designation Number: 418586 / TW1078

Approved by :


Jim Hsiang / Associate Technical Manager

Date: Jan. 21, 2021

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Prepared by : Albee Chu / Specialist

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October 3, 2022